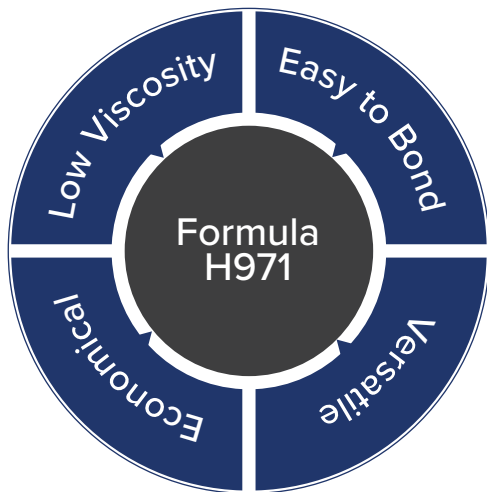




# Formulation H971 Adhesive

- Low Viscosity
- Easy to Bond to Substrates
- Competitively priced



*Selecting the Right Adhesive  
is Quick and Easy.*

*Our experts will help you choose  
the ideal combination of melting point,  
bond strength, service life and chemistry  
to create the most effective  
adhesive solution.*

Formula H971 from GDI Adhesives has been designed as a lower cost formula, for undemanding basic applications. Good performance relative to competitive price with enhanced mechanical properties.

This adhesive is used in a variety of Industries including flooring, packaging, and lamination.

- ⌵ Low Stress Bonding Applications
- ⌵ Low Viscosity – 2,700 to 4,300 CPs @ 350°F
- ⌵ Melting Point – 185°F to 215°F